DATA SHEET

# **2322 661 97...** Surface mount PTC thermistors for overload protection

Product specification Supersedes data of 17th May 1999 File under BCcomponents, BC02 2001 Feb 14



### FEATURES

- Ideal for pick-and-place circuit assembly
- Low mounting height
- Suitable for reflow soldering
- Small ceramic diameter for faster response
- Low heat transfer to substrate
- Flat terminations for stable positioning and good solderability.

### APPLICATIONS

- Telecom
  - Central office switching (C.O.)
  - Subscriber terminal equipment (T.E.)
  - Set top box
  - Modems
- Cable TV communications
- General industry and automotive
  - Low power supplies overload protection
  - Data bus protection.

### DESCRIPTION

The component consists of a high-performance PTC ceramic disc mounted in a lead-frame for direct soldering onto a printed-circuit board (PCB) or substrate.

The ceramic is soldered to the leadframe by a local reflow process, during which the solder layer is melted to the metallized ceramic surface using a low residue flux.

### QUICK REFERENCE DATA

| DESCRIPTION                                    | VA                                       | VALUE                           |  |  |  |
|--|--|---------------------------------|--|--|--|
| DESCRIPTION                                    | STANDARD TYPES <sup>(1)(2)</sup>         | TELECOM TYPES <sup>(1)(2)</sup> |  |  |  |
| Nominal R25                                    | 2 to 500 Ω                               | 10 to 70 Ω                      |  |  |  |
| Resistance tolerance ±10%; ±15%; ±20%          |  |                                 |  |  |  |
| Maximum overload current (voltage dependent)   | 2 to                                     | 2 to 10 A                       |  |  |  |
| Non-trip current                               | 50 to 500 mA at 25 °C                    | 50 to 100 mA at 70 °C           |  |  |  |
| Maximum voltage                                | 16 to 400 V (RMS)                        | 220 to 600 V ( RMS)             |  |  |  |
| Response time at 25 °C and 20 W overload power | ne at 25 °C and 20 W overload power <1 s |                                 |  |  |  |
| Matching                                       | -  | down to 0.5 $\Omega$            |  |  |  |
| Maximum continuous power at 25 °C              | 2 W                                      |                                 |  |  |  |

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### Notes

- 1. Customized products between the resistance ranges are available on request.
- 2. Coated and/or reinforced types are available on request.



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### SOLDERING CONDITIONS

This SMD thermistor is only suitable for reflow soldering, in accordance with "CECC 00802". Soldering processes which can be used are reflow (infrared and convection heating) and vapour phase. The maximum temperature of 260 °C during 10 s should not be exceeded and no liquid flux should be allowed to reach the ceramic body.

Typical examples of a soldering processes that will provide reliable joints without damage, are shown in Figs 2 and 3.



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### MECHANICAL DATA

| Table 1         Material information; see Fig.5 |               |  |  |  |  |
|---|---------------|--|--|--|--|
| REF.  | DESCRIPTION   | MATERIAL AND REMARKS   |  |  |  |
| 1   | ceramic       | BaTiO <sub>3</sub> doped   |  |  |  |
| 2   | metallization | NiCr Ag layer<br>(vacuum deposition)                                   |  |  |  |
| 3   | leadframe     | Ni plated phosphor bronze<br>material covered by PbSn8<br>solder layer |  |  |  |



### Marking

• All SMD PTCs are marked with the last 3-digits of the type number and a date code (YYWW).

### Handling precautions

The special leadframe construction and the applied processes do not allow high handling forces on the component. Because of the nature of PTC ceramic material the component should not be touched with bare hands, as the residue of perspiration can influence component behaviour at high temperatures.

Handling forces vertically applied to the centre of the component should be limited to 5 N in the non-soldered condition and to 10 N in the soldered. These forces should not be exceeded during the handling, transportation and packaging of the soldered product.

For those applications where higher handling forces can be present, a re-inforced version is available on request.

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#### **PTC outlines**



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### ELECTRICAL DATA

 Table 2
 Ceramic size: 6.5 and 7.1 mm; see Figs 6 and 7

| R <sub>2</sub>          | 5            | V<br>MAX.         | I <sub>nt</sub> | at    | I <sub>t</sub> at |                       | AX.<br>TIME               | MATCHED<br>PAIRS | CERAMIC<br>SIZE |                    |  |
|-------------------------|--------------|-------------------|-----------------|-------|-------------------|-----------------------|---------------------------|------------------|-----------------|--------------------|--|
| (Ω)                     | (%)          | (V)               | 25 °C           | 70 °C | 25 °C             | t <sub>t</sub><br>(s) | at I <sub>t</sub><br>(mA) | AVAILABLE        | (mm)            | NUMBER<br>2322 661 |  |
| Telecommu               | nication ty  | <b>oes</b> ; note | e 1             |       |                   |                       |                           |                  |                 |                    |  |
| 40                      | 25           | 265               | 80              | 50    | 130               | 2.5                   | 500                       | no               | 6.5             | 97002              |  |
| 15 to 20 <sup>(1)</sup> | -            | 300               | 150             | 100   | 250               | 1.5                   | 1000                      | 0.5 Ω            | 6.5             | 97003              |  |
| 15 to 20 <sup>(1)</sup> | -            | 300               | 150             | 100   | 250               | 1.5                   | 1000                      | no               | 6.5             | 97004              |  |
| 25 <sup>(1)</sup>       | 20           | 265               | 120             | 70    | 220               | 1.3                   | 1000                      | 1 Ω              | 6.5             | 97005              |  |
| 35(1)                   | +15/-20      | 425               | 110             | 70    | 175               | 1.0                   | 1000                      | 1 Ω              | 6.5             | 97009              |  |
| 10 <sup>(1)</sup>       | 20           | 245               | 165             | 100   | 270               | 3.0                   | 1000                      | no               | 6.5             | 97012              |  |
| 10 <sup>(1)</sup>       | 20           | 245               | 165             | 100   | 270               | 3.0                   | 1000                      | 0.5 Ω            | 6.5             | 97016              |  |
| 20 <sup>(1)</sup>       | 20           | 300               | 120             | 70    | 250               | 1.4                   | 1000                      | 0.5 Ω            | 6.5             | 97018              |  |
| 50                      | 20           | 425               | 90              | 60    | 150               | 0.8                   | 1000                      | 1 Ω              | 6.5             | 97019              |  |
| 10 <sup>(1)</sup>       | 20           | 300               | 150             | 100   | 250               | 3.0                   | 1000                      | 0.5 Ω            | 7.1             | 97203              |  |
| 25 <sup>(1)</sup>       | 20           | 400               | 120             | 70    | 220               | 2.0                   | 1000                      | 1 Ω              | 7.1             | 97204              |  |
| 50 <sup>(1)</sup>       | 20           | 600               | 70              | 40    | 140               | 0.7                   | 1000                      | 1 Ω              | 7.1             | 97205              |  |
| General ind             | ustrial type | s                 |                 |       |                   |                       |                           |                  |                 |                    |  |
| 9.4 <sup>(1)</sup>      | 25           | 60                | 150             | 100   | 300               | 4.0                   | 600                       | -                | 6.5             | 97011              |  |
| 3.3 <sup>(1)</sup>      | 25           | 24                | 400             | -     | 650               | 6.0                   | 1000                      | -                | 6.5             | 97013              |  |

#### Note

1. These types pass "ITU-T K20/21" telecommunication protection recommendation.

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### PACKAGING

### Tape specifications

All tape and reel specifications are in accordance with *"IEC 60286-3"*. Basic dimensions are given in Figs 8 and 12, and Tables 3 and 4. Carrier tape material is conductive polystyrene or polycarbonate.

#### Blister tape



| Table 3 | Dimensions | of blister | tane in   | millimetres | see Fin 8 |
|---------|------------|------------|-----------|-------------|-----------|
| Idule 3 | DIMENSIONS | UI DIISIEI | lape, III | minimetres, | see rig.o |

| SYMBOL                    | PRODUCT SIZE CODE | TOL.      |
|---------------------------|-------------------|-----------|
| A <sub>0</sub> ; note 1   | 7.5               | ±0.1      |
| B <sub>0</sub> ; note 1   | 10.5              | ±0.1      |
| K <sub>0</sub>            | 4.1               | ±0.1      |
| W                         | 16                | ±0.3      |
| E                         | 1.75              | ±0.1      |
| F                         | 7.5               | ±0.1      |
| D <sub>0</sub>            | 1.5               | +0.1/-0.0 |
| D <sub>1</sub>            | 1.5               | +0.1/-0.0 |
| P <sub>0</sub> ; note 2   | 4                 | ±0.1      |
| P <sub>1</sub>            | 12                | ±0.1      |
| P <sub>2</sub>            | 2                 | ±0.1      |
| T tape thickness          | 0.3               | ±0.03     |
| T <sub>1</sub> cover tape | 0.05              | _         |
| T <sub>2</sub>            | 4.6               | max.      |

### Notes

- 1. Measured 0.3 mm above base pocket.
- 2.  $P_0$  pitch tolerance over any 10 pitches is ±0.2 mm.

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### Leader/trailer tape specification



### Taping package requirements

Component is free and not sticking to top and/or bottom tape.

Component should be easy to remove from carrier tape.

### Peel-off force

Peel-off force of blister tape is in accordance with "IEC 60286-3"; that is, 0.1 to 1.3 N at a peel-off speed of 300 mm/minute.



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#### **Reel specifications**



| Table 4 | Reel dimensions; see note 1 and Fig.12 |  |
|---------|--|--|
|---------|--|--|

| PRODUCT SIZE<br>CODE | UNITS <sup>(2)</sup><br>PER REEL | TAPE WIDTH<br>(mm) | A<br>(mm) | N<br>(mm) | W <sub>1</sub><br>(mm) | W <sub>2</sub><br>MAX.<br>(mm) |
|----------------------|----------------------------------|--------------------|-----------|-----------|------------------------|--------------------------------|
| 4028                 | 1500                             | 16                 | 330       | 62        | 16.4                   | 20.4                           |

#### Notes

- 1. Reels are packed in sealed plastic bags for protection against high humidity and corrosive atmospheres.
- 2. For matched components it is possible to have a maximum of one incomplete reel per resistance group. The minimum packaging quantity will be 500 units, with an even 100 up to 1400.